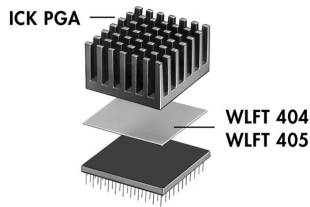


Data sheet Product ICK PGA 18 x 18

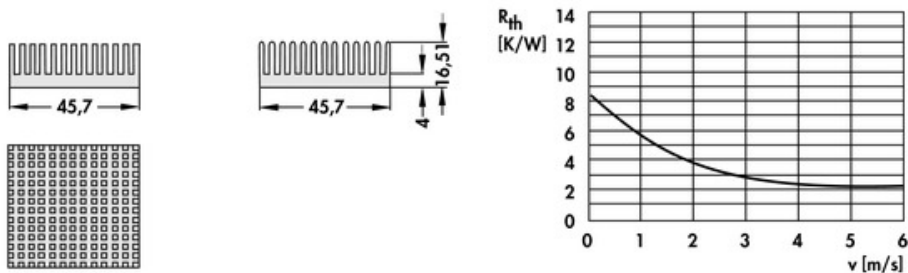


Heatsinks and active heatsinks for processors>Heatsinks for PGA
45,7 x 45,7 x 16,5 mm, for IC design PGA and others

Features

way of fixation:	• therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
width:	45.7 mm
height:	16.51 mm
plate thickness:	4 mm
length:	45.7 mm
thermal resistance:	8.4 - 2.2 K/W
dissipation loss:	7.2 W
surface:	black anodised

Technical Drawing



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